Is Now Part of

ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

FAIRCHILD SEMICONDUCTOR®

July 2012

NC7WV07
TinyLogic® ULP-A Bual Buffer (Open-Drain Output)

Features

- 0.9V to 3.6V V_{CC} Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at V_{CC} from 0.9V to 3.6V
- Extremely High Speed t_{PD}
  - 1.0ns: Typical for 2.7V to 3.6V V_{CC}
  - 1.2ns: Typical for 2.3V to 2.7V V_{CC}
  - 2.0ns: Typical for 1.65V to 1.95V V_{CC}
  - 3.2ns: Typical for 1.4V to 1.6V V_{CC}
  - 6.0ns: Typical for 1.1V to 1.3V V_{CC}
  - 13.0ns: Typical for 0.9V V_{CC}
- Power-Off High-Impedance Inputs and Outputs
- High Static Drive (I_{OH}/I_{OL})
  - ±24mA at 3.00V V_{CC}
  - ±18mA at 2.30V V_{CC}
  - ±6mA at 1.65V V_{CC}
  - ±4mA at 1.4V V_{CC}
  - ±2mA at 1.1V V_{CC}
  - ±0.1mA at 0.9V V_{CC}
- Uses Proprietary Quiet Series™ Noise/EMI Reduction Circuitry
- Ultra-Small MicroPak™ Packages
- Ultra-Low Dynamic Power

Description

The NC7WV07 is a dual buffer with open drain output from Fairchild's Ultra Low Power-A series of TinyLogic® ULP-A is ideal for applications that require extreme high speed, high drive and low power. This product is designed for a wide low voltage operating range (0.9V to 3.6V V_{CC}) and applications that require more drive and speed than the TinyLogic ULP series, but still offer best in class low power operation.

The NC7WV07 is uniquely designed for optimized power and speed, and is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7WV07P6X	V07	6-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7WV07L6X	BC	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel

TinyLogic® is a registered trademark of Fairchild Semiconductor Corporation.
MicroPak™ and Quiet Series™ are trademarks of Fairchild Semiconductor Corporation.

Battery Life

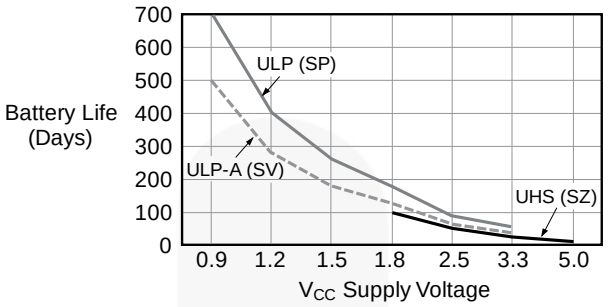


Figure 1. Battery Life vs. V_{CC} Supply Voltage

Notes:

1. TinyLogic® ULP and ULP-A with up to 50% less power consumption can extend battery life significantly.
   Battery Life = $(V_{battery} \bullet I_{battery} \bullet .9)/(P_{device})$/24hrs/day
   where, $P_{device} = (I_{CC} \bullet V_{CC}) + (C_{PD} + C_L) \bullet V_{CC2} \bullet f$.
2. Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAH and derated 90% and device frequency at 10MHz, with C_L=15pF load.

Pin Configurations

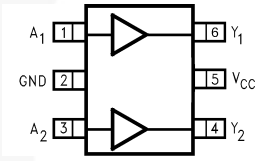


Figure 2. SC70 (Top View)

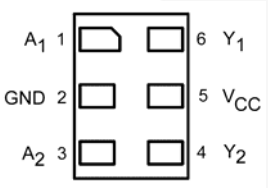


Figure 3. MicroPak (Top Through View)

Pin Definitions

Pin # SC70	Pin # MicroPak	Name	Description
1	1	A_1	Data Inputs
2	2	GND	Ground
3	3	A_2	Data Inputs
4	4	Y_2	Output
5	5	V_{CC}	Supply Voltage
6	6	Y_1	Output

Function Table

Inputs	Output
A	**Y**
L	L
H	*H

H=HIGH Logic Level

L=LOW Logic Level

*H=HIGH Impedance Output Status (Open Drain)

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V_{CC}	Supply Voltage		-0.5	4.6	V
V_{IN}	DC Input Voltage		-0.5	4.6	V
V_{OUT}	DC Output Voltage		-0.5	4.6	V
I_{IK}	DC Input Diode Current	V_{IN} < 0V		-50	mA
I_{OK}	DC Output Diode Current	V_{OUT} < 0V		-50	mA
I_{OL}	DC Output Sink Current			+50	mA
I_{CC} or I_{GND}	DC V_{CC} or Ground Current per Supply Pin			±50	mA
T_{STG}	Storage Temperature Range		-65	+150	°C
T_J	Junction Temperature Under Bias			+150	°C
T_L	Junction Lead Temperature, Soldering 10 Seconds			+260	°C
P_D	Power Dissipation at +85°C	SC70-5		150	mW
		MicroPak-6		130	
		MicroPak2-6		120	
ESD	Human Body Model, JEDEC:JESD22-A114			4000	V
	Charge Device Model, JEDEC:JESD22-C101			2000	

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Max.	Unit
V_{CC}	Supply Voltage		0.9	3.6	V
V_{IN}	Input Voltage		0	3.6	V
V_{OUT}	Output Voltage		0	3.6	V
I_{OL}	Output Current in I_{OL}	V_{CC}=3.0V to 3.6V		+24.0	mA
		V_{CC}=2.3V to 3.6V		+18.0	
		V_{CC}=1.65V to 1.95V		+6.0	
		V_{CC}=1.4V to 1.6V		+4.0	
		V_{CC}=1.1V to 1.3V		+2.0	
		V_{CC}=0.9V		+0.1	
T_A	Operating Temperature, Free Air		-40	+85	°C
$\Delta t/\Delta V$	Minimum Input Edge Rate	V_{IN}=0.8V to 2.0, V_{CC}=3.0V		10	ns/V
θ_{JA}	Thermal Resistance	SC70-5		425	°C/W
		MicroPak-6		500	

Note:

3. Unused inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C		T_A=-40 to 85°C		Units
				Min.	Max.	Min.	Max.	
V_{IH}	HIGH Level Input Voltage	0.90		.65 x V_{CC}		.65 x V_{CC}		V
		1.10 ≤ V_{CC} ≤ 1.30		.65 x V_{CC}		.65 x V_{CC}		
		1.40 ≤ V_{CC} ≤ 1.60		.65 x V_{CC}		.65 x V_{CC}		
		1.65 ≤ V_{CC} ≤ 1.95		.65 x V_{CC}		.65 x V_{CC}		
		2.30 ≤ V_{CC} ≤ 2.70		1.6		1.6		
		2.70 ≤ V_{CC} ≤ 3.60		2.0		2.0		
V_{IL}	LOW Level Input Voltage	0.90			.35 x V_{CC}		.35 x V_{CC}	V
		1.10 ≤ V_{CC} ≤ 1.30			.35 x V_{CC}		.35 x V_{CC}	
		1.40 ≤ V_{CC} ≤ 1.60			.35 x V_{CC}		.35 x V_{CC}	
		1.65 ≤ V_{CC} ≤ 1.95			.35 x V_{CC}		.35 x V_{CC}	
		2.30 ≤ V_{CC} ≤ 2.70			0.7		0.7	
		2.70 ≤ V_{CC} ≤ 3.60			0.8		0.8	
V_{OL}	LOW Level Output Voltage	0.90	I_{OL}=100µA		0.1		0.1	V
		1.10 ≤ V_{CC} ≤ 1.30			0.1		0.1	
		1.40 ≤ V_{CC} ≤ 1.60			0.2		0.2	
		1.65 ≤ V_{CC} ≤ 1.95			0.2		0.2	
		2.30 ≤ V_{CC} ≤ 2.70			0.2		0.2	
		2.70 ≤ V_{CC} ≤ 3.60			0.2		0.2	
		1.10 ≤ V_{CC} ≤ 1.30	I_{OL}=2mA		0.25 x V_{CC}		0.25 x V_{CC}	
		1.40 ≤ V_{CC} ≤ 1.60	I_{OL}=4mA		0.25 x V_{CC}		0.25 x V_{CC}	
		1.65 ≤ V_{CC} ≤ 1.95	I_{OL}=6mA		0.3		0.3	
		2.30 ≤ V_{CC} ≤ 2.70	I_{OL}=12mA		0.4		0.4	
		2.70 ≤ V_{CC} ≤ 3.60			0.4		0.4	
		2.30≤ V_{CC} ≤ 2.70	I_{OL}=18mA		0.6		0.6	
		2.70 ≤ V_{CC} ≤ 3.60			0.4		0.4	
		2.70 ≤ V_{CC} ≤ 3.60	I_{OL}=24mA		0.55		0.55	
I_{IN}	Input Leakage Current	0.90 to 3.60	0 ≤ V_{IN} ≤ 3.60		±0.1		±0.5	µA
I_{OFF}	Power Off Leakage Current	0	0 ≤ ($V_{IN,}$ V_O) ≤ 3.60		0.5		0.5	µA
I_{CC}	Quiescent Supply Current	0.90 to 3.60	V_{IN}=V_{CC}, or GND		0.9		0.9	µA
			V_{CC} ≤ V_{IN} ≤ 3.6V				±0.9	

AC Electrical Characteristics

Symbol	Parameter	V_{CC}	Conditions	T_A=25°C			T_A=-40 to 85°C		Units	Figure
				Min.	Typ.	Max.	Min.	Max.		
t_{PZL}, t_{PLZ}	Propagation Delay	0.90	C_L=15pF, R_U=R_D=1MΩ		13				ns	Figure 4 Figure 5
		1.10 ≤ V_{CC} ≤ 1.30	C_L=15pF, R_U=R_D=2kΩ	2.0	6.0	15.0	1.0	18.6		
		1.40 ≤ V_{CC} ≤ 1.60		1.0	3.2	8.7	1.0	9.7		
		1.65 ≤ V_{CC} ≤ 1.95	C_L=30pF, R_U=R_D=500Ω	1.0	2.0	6.0	1.0	6.8		
		2.30 ≤ V_{CC} ≤ 2.70		0.7	1.2	3.6	0.6	4.7		
		2.70 ≤ V_{CC} ≤ 3.60		0.5	1.0	3.3	0.4	4.0		
C_{IN}	Input Capacitance	0			2				pF	
C_{OUT}	Output Capacitance	0			6.5					
C_{PD}	Power Dissipation Capacitance	0.90 to 3.60	V_{IN}=0V or V_{CC}, f=10MHz		10				pF	

AC Loadings and Waveforms

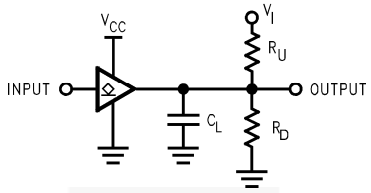


Figure 4. AC Test Circuit

Test	Switch
t_{PZL}, t_{PLZ}	6V at V_{CC}=3.3±0.3V; V_{CC} x 2 at V_{CC}=0.9-2.7V

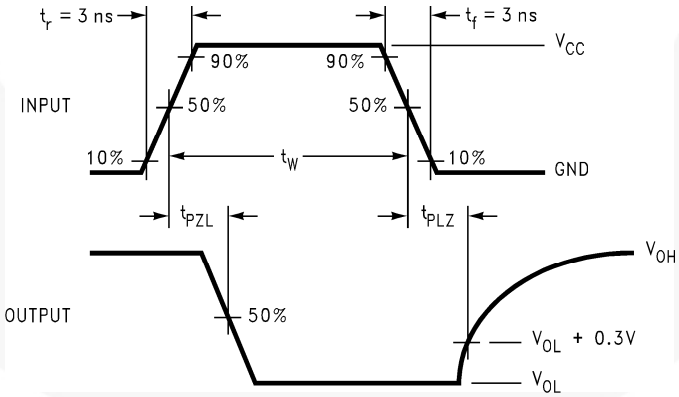


Figure 5. AC Waveforms for Inverting and Non-Inverting Functions

Symbol	V_{CC}					
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V	1.5V ± 0.1V	1.2V ± 0.1V	0.9V
V_{mi}	1.5V	V_{CC}/2	V_{CC}/2	V_{CC}/2	V_{CC}/2	V_{CC}/2
V_{mo}	V_{OL} + 0.30V	V_{OL} + 0.15V	V_{OL} + 0.15V	V_{OL} + 0.10V	V_{OL} + 0.10V	V_{OL} + 0.10V

Physical Dimensions

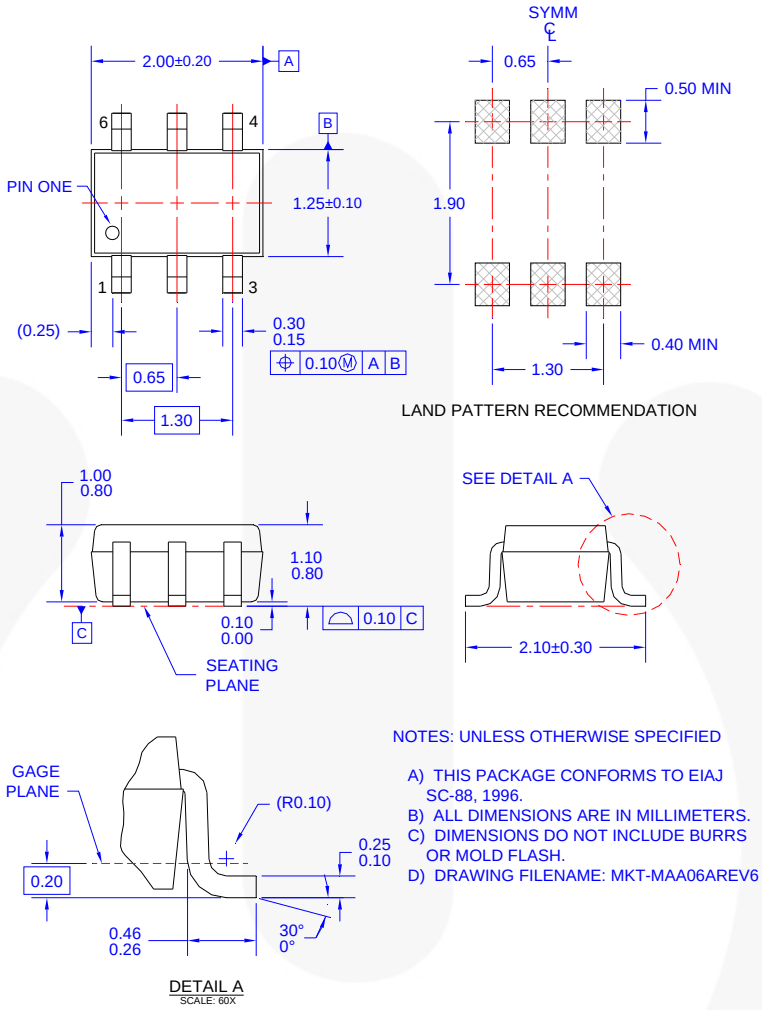


Figure 6. 6-Lead, SC70, EIAJ SC-88a, 1.25mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

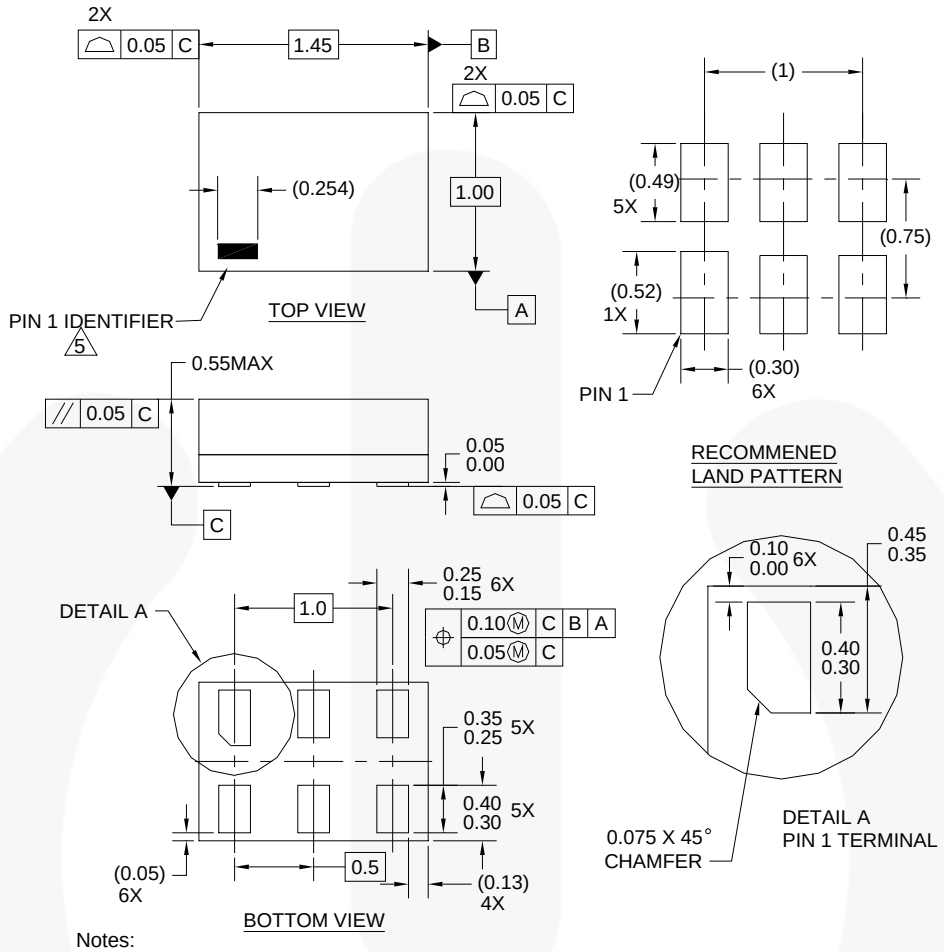
Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
http://www.fairchildsemi.com/packaging/.

Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/analog/pdf/sc70-6_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

Physical Dimensions



Notes:

1. CONFORMS TO JEDEC STANDARD M0-252 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y14.5M-1994
4. FILENAME AND REVISION: MAC06AREV4
5. PIN ONE IDENTIFIER IS 2X LENGTH OF ANY OTHER LINE IN THE MARK CODE LAYOUT.

Figure 7. 6-Lead, MicroPak™, 1.0mm Wide

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

Always visit Fairchild Semiconductor's online packaging area for the most recent package drawings:
http://www.fairchildsemi.com/packaging/.

Tape and Reel Specification

Please visit Fairchild Semiconductor's online packaging area for the most recent tape and reel specifications:
http://www.fairchildsemi.com/products/logic/pdf/micropak_tr.pdf.

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
L6X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed

FAIRCHILD SEMICONDUCTOR®

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

2Cool™
AccuPower™
AX-CAP™*
BitSiC™
Build it Now™
CorePLUS™
CorePOWER™
CROSSVOLT™
CTL™
Current Transfer Logic™
DEUXPEED®
Dual Cool™
EcoSPARK®
EfficientMax™
ESBC™
F®
Fairchild®
Fairchild Semiconductor®
FACT Quiet Series™
FACT®
FAST®
FastvCore™
FETBench™
FlashWriter®*
FPS™
F-PFS™
FRFET®
Global Power Resource℠
GreenBridge™
Green FPS™
Green FPS™ e-Series™
Gmax™
GTO™
IntelliMAX™
ISOPLANAR™
Making Small Speakers Sound Louder and Better™
MegaBuck™
MICROCOUPLER™
MicroFET™
MicroPak™
MicroPak2™
MillerDrive™
MotionMax™
mWSaver™
OptoHiT™
OPTOLOGIC®
OPTOPLANAR®
PowerTrench®
PowerXS™
Programmable Active Droop™
QFET®
QS™
Quiet Series™
RapidConfigure™
™
Saving our world, 1mW/W/kW at a time™
SignalWise™
SmartMax™
SMART START™
Solutions for Your Success™
SPM®
STEALTH™
SuperFET®
SuperSOT™-3
SuperSOT™-6
SuperSOT™-8
SupreMOS®
SyncFET™
Sync-Lock™
SYSTEM GENERAL®*
The Power Franchise®
the power franchise
TinyBoost™
TinyBuck™
TinyCalc™
TinyLogic®
TINYOPTO™
TinyPower™
TinyPWM™
TinyWire™
TranSiC™
TriFault Detect™
TRUECURRENT®*
μSerDes™
μSerDes
UHC®
Ultra FRFET™
UniFET™
VCX™
VisualMax™
VoltagePlus™
XS™

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

Rev. I62